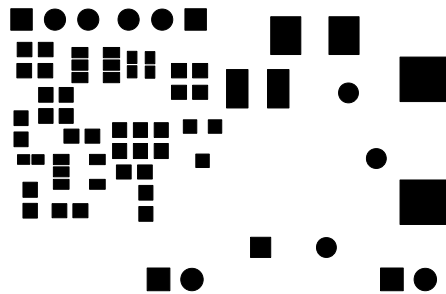
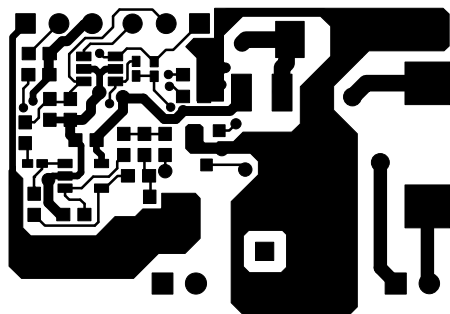


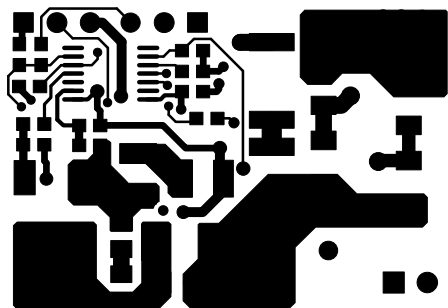
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = TIDA-00284.GTO	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	



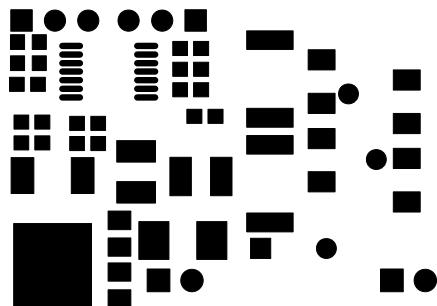
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = TIDA-00284.GTS	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	



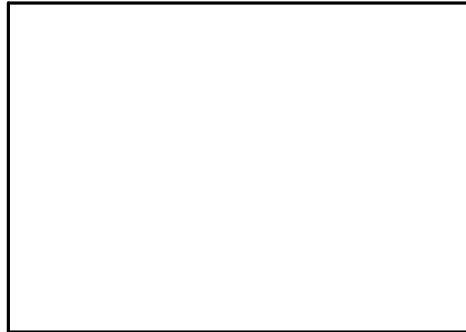
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LAYER NAME = Top Layer			
PLOT NAME = TIDA-00284.GTL	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = TIDA-00284.GBL	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = TIDA-00284.GBS	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00284	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = TIDA-00284.GM1	GENERATED : 9/29/2014 11:10:19 AM	TEXAS INSTRUMENTS	

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